

Single-channel EiceDRIVER™ with true differential inputs

Feature list

- Single-channel non-isolated gate-drive IC with true differential inputs
- Very large common-mode input voltage range (CMR) up to ± 150 V (Table 1)
- Supply voltage (V_{DD}) up to 20 V
- 2 UVLO options: 4 V and 8 V
- Separate low impedance source and sink outputs
 - 4 A / 0.85Ω source
 - $8 A/0.35 \Omega sink$
- 45 ns propagation delay with -7 / +10 ns accuracy
- SOT23 6-pin package
- Fully qualified for industrial applications according to JEDEC



Description

1EDNx550 is a new family of single-channel non-isolated gate-driver ICs. Due to the unique fully differential input circuitry with excellent common-mode rejection, the logic driver state is exclusively controlled by the voltage difference between the two inputs, completely independent of the driver's reference (ground) potential. This eliminates the risk for wrong triggering and thus is a significant benefit in all applications exhibiting voltage differences between driver and controller ground, a problem typical for systems with

- 4-pin packages (Kelvin Source connection)
- high parasitic PCB inductances (long distances, single-layer PCB)
- bipolar gate drive

In addition, within the allowed common-mode voltage range, CMR (*Table 1*), 1EDNx550 allows to address even high-side applications.

Table 1 Product portfolio

Part number	CMR static	R static CMR dynamic		Package	Orderable Part Number
1EDN7550B	+ 72 V / - 84 V	± 150 V	4 V	PG-SOT23-6	1EDN7550BXTSA1
1EDN8550B	+ 72 V / - 84 V	± 150 V	8 V	PG-SOT23-6	1EDN8550BXTSA1

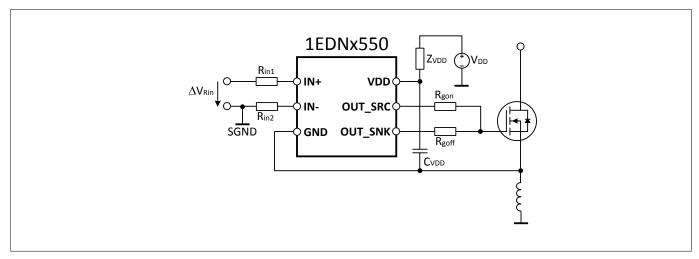


Figure 1 Typical application

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Pin configuration and description

Pin configuration and description 1

The pin configuration for the SOT23 6-pin package is illustrated in *Figure 2*; a description is given in *Table 2*. For functional details, please read Chapter 3.

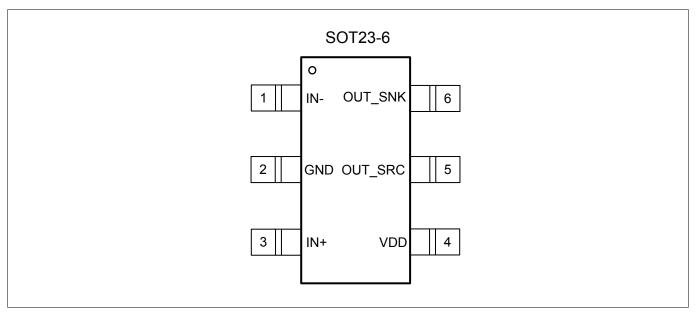


Figure 2 Pin configuration SOT23 6-pin (top side view)

Table 2 Pin description

Symbol	Description								
IN+	Positive input								
	connected to PWM output of controller via resistor (typically 33 $k\Omega)$								
IN-	Negative input								
	connected to controller ground via resistor (typically 33 k Ω)								
GND	Ground								
	negative gate drive voltage ("off" state)								
VDD	Positive supply voltage								
	positive gate drive voltage ("on" state)								
OUT_SNK	Driver output sink								
	low-impedance switch to GND (8 A / 0.35 Ω)								
OUT_SRC	Driver output source								
	low-impedance switch to VDD (4 A / 0.85Ω)								



Block diagram

Block diagram 2

A simplified functional block diagram of 1EDNx550 is given in *Figure 3*.

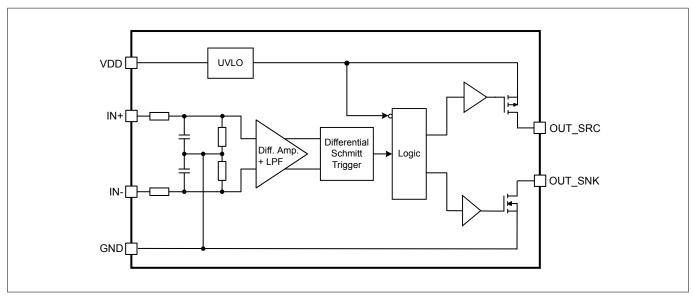


Figure 3 **Block diagram**

Single-channel EiceDRIVER™ with true differential inputs



Functional description

3 **Functional description**

1EDNx550 is a fast single-channel non-isolated gate driver. However, compared with standard drivers, this new gate driver family extends the range of possible applications into fields usually reserved for isolated drivers, thereby generating significant system cost benefits.

The key to make this possible, is moving from the standard ground related to a true differential input with very high common-mode rejection. The required symmetry of the input circuitry is achieved by on-chip trimming; it finally allows to deal with peak common-mode voltages of up to ± 150 V between driver reference (GND) and system ground (SGND). 1EDNx550 is not only ideally suited for any application with unwanted shifts between driver and system ground, but may also be utilized as a high-side driver within the allowed common-mode range. Besides, switches requiring a bipolar driving voltage can be operated very easily.

3.1 Differential input

Figure 4 depicts the signal path from the controller's PWM output to the logic gate driver signal as implemented on 1EDNx550.

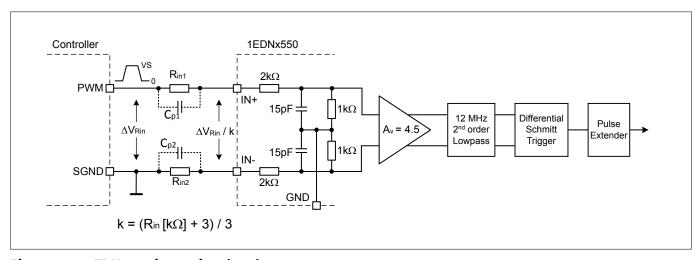


Figure 4 1EDNx550 input signal path

The controller output signal, switching between controller supply VS and zero, is applied at the one leg of a differential voltage divider, while the other is connected to the controller ground SGND. The divider ratio has to be adapted to VS to allow a fixed Schmitt-Trigger threshold voltage. For VS = 3.3 V, $R_{\rm in1}$ and $R_{\rm in2}$ are chosen to be 33 k Ω , resulting in a static divider ratio of k = 12 at the driver inputs and 36 at the internal voltage amplifier. With VS other than 3.3 V, R_{in} has to fulfil the relation: $R_{in1} = R_{in2} = 10.9 \text{ VS} - 3 \text{ [k}\Omega]$

Amplified by a factor of 4.5, the signal is filtered by a 2nd order low-pass filter. Taking into account the RC filter in front of the amplifier, the overall input path exhibits the frequency behavior of a 3rd order low-pass filter with a corner frequency around 12 MHz. The suppression of high frequencies is important for two reasons. Inductive common-mode ringing in fast-switching power systems is typically in the 100 MHz and above range and thus is effectively damped. The high-frequency symmetry of the voltage divider is influenced by parasitic capacitances, particularly C_{p1} and C_{p2} , the parallel capacitances of R_{in1} and R_{in2} . They are typically in the 50 to 100 fF range, rather independent of resistor size. Without filtering, any asymmetry would translate high-frequency commonmode into differential signals.

The filtered signal is then applied to a differential Schmitt-Trigger with accurate trimmed threshold levels and converted to the logic switch control signal. The subsequent pulse extender function guarantees that no pulses shorter than 25 ns are transmitted to the output, thereby further improving noise immunity.

Due to the filtering requirements the input-to-output propagation delay is slightly increased to around 45 ns. By means of on-chip trimming, however, the usually more relevant propagation delay variation can still be kept low at +10 / -7 ns.

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Functional description

3.1.1 **Common mode input range**

There are two effects limiting the common-mode input range, i.e. the maximum allowed voltage difference between controller outputs PWM/SGND and driver reference GND: the circuit and technology-related input voltage restrictions and the finite common-mode rejection in the input signal path due to asymmetries.

The static voltage range at the input pins is limited to +6 / -7 V to guarantee accurate linear operation of the input circuitry. Taking into account the proposed DC voltage divider ratio, this translates to a static commonmode range of + 72 / - 84 V. This range, however, is increased, if the high-frequency common-mode voltages typical for inductive ringing in fast-switching power systems are considered, as in this case the maximum ratings at the input pins are applicable (± 10 V). Together with the frequency-dependence of the voltage divider ratio due to the input RC-filter this leads to a usable dynamic common-mode range of ± 150 V.

The second limitation results from the fact that any imbalance in the signal path converts a common-mode to a differential signal. To utilize the full common-mode range as calculated above, the high accuracy of the trimmed on-chip network must not be affected by the external voltage divider resistors. This condition is easily fulfilled when choosing $R_{\text{in}1}$ and $R_{\text{in}2}$ with 0.1% tolerance; resistors with only 1% accuracy, however, would reduce the common-mode range significantly to \pm 40 V.

Driver outputs 3.2

The rail-to-rail driver output stage realized with complementary MOS transistors is able to provide a typical 4 A sourcing and 8 A sinking current. The low on-resistance coming together with high driving current is particularly beneficial for fast switching of very large MOSFETs. With a $R_{\rm on}$ of 0.85 Ω for the sourcing pMOS and 0.35 Ω for the sinking nMOS transistor the driver can be considered in most applications to behave like an ideal switch. The p-channel sourcing transistor allows real rail-to-rail behavior without suffering from the source-follower's voltage drop typical for n-channel output stages.

In case of floating inputs or insufficient supply voltage the driver output is actively clamped to the "low" level (GND).

3.3 Supply voltage and Undervoltage Lockout (UVLO)

The Undervoltage Lockout function ensures that the output can be switched only, if the supply voltage $V_{\rm DD}$ exceeds the UVLO threshold voltage. Thus it can be guaranteed that the switch transistor is not operated, if the driving voltage is too low to achieve a complete and fast transition to the "on" state, thereby avoiding excessive power dissipation.

1EDNx550 is available in two versions differing in UVLO threshold to support switches with a broad range of threshold voltages

- 1EDN7550 with a typical UVLO threshold of 4.2 V (0.3 V hysteresis)
- 1EDN8550 with a typical UVLO threshold of 8 V (1 V hysteresis)

In addition, the high maximum $V_{\rm DD}$ of 20 V makes the driver family well suited for a broad variety of power switch types.

1EDN7550 and 1EDN8550Single-channel EiceDRIVER[™] with true differential inputs



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Electrical characteristics and parameters

4 Electrical characteristics and parameters

The absolute maximum ratings are listed in *Table 3*. Stresses beyond these values may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

4.1 Absolute maximum ratings

Table 3 Absolute Maximum Ratings

Parameter	Symbol Values				Unit	Note or Test Condition
		Min.	Тур.	Max.		
Supply voltage	V_{DD}	-0.3	-	22	V	Voltage between VDD to GND
Voltage at pins IN+ and IN-	V _{IN}	-10	_	10	V	-
Voltage at pins OUT_SRC and OUT_SNK	V _{INPUT}	-0.3	-	V _{DD} +0.3	V	-
Peak reverse current at OUT_SRC	I _{SRC_rev}	-5	-	-	А	< 500 ns
Peak reverse current at OUT_SRC	I _{SRC_rev}	-	-	5	А	< 500 ns
Junction temperature	T _j	-40	_	150	°C	-
Storage temperature	T_{S}	-55	_	150	°C	-
ESD capability	V _{ESD_HBM}	-	-	2	kV	Human Body Model (HBM) ¹⁾
ESD capability	V _{ESD_CDM}	_	-	0.5	kV	Charged Device Mode (CDM)

¹ According to EIA/JESD22-A114-B (discharging 100 pF capacitor through 1.5 kΩ resistor)

Single-channel EiceDRIVER™ with true differential inputs



Electrical characteristics and parameters

4.2 Thermal characteristics

Thermal characteristics Table 4

Parameter	Symbol Values				Unit	Note or Test Condition
		Min.	Тур.	Max.		
Thermal resistance junctionambient ²⁾	R _{thJA25}	-	170	_	K/W	-
Thermal resistance junction- case (top) ³⁾	R _{thJC25}	-	81	_	K/W	-
Thermal resistance junction- board ⁴⁾	R _{thJB25}	-	52	_	K/W	-
Characterization parameter junction-case (top) ⁵⁾	ψ_{thJC25}	-	14	_	K/W	-
Characterization parameter junction-board ⁶⁾	ψ_{thJB25}	-	51	_	K/W	-

4.3 **Operating range**

Table 5 **Operating Range**

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Тур.	Max.		
Supply voltage	V_{DD}	4.5	_	20	٧	Min defined by UVLO
Voltage at pins IN+ and IN-	V _{IN}	-7	_	6	V	-
Junction temperature	Tj	-40	_	150	°C	7)

² Obtained in a simulation on a JEDEC-standard, high-K board, as specified in JESD51-7, in an environment described in JESD51-2a

³ Obtained by simulating a cold plate test on the package top. No specific JEDEC standard test exists, but a close description can be found in the ANSI SEMI standard G30-88

⁴ Obtained by simulating in an environment with a ring cold plate fixture to control the PCB temperature, as described in JESD51-8

⁵ Estimates the junction temperature of a device in a real system and is extracted from the simulation data for obtaining R_{th}, using a procedure described in JESD51-2a (sections 6 and 7)

⁶ Estimates the junction temperature of a device in a real system and is extracted from the simulation data for obtaining R_{th}, using a procedure described in JESD51-2a (sections 6 and 7)

⁷ Continuous operation above 125°C may reduce life time

Single-channel EiceDRIVER™ with true differential inputs



Electrical characteristics and parameters

4.4 Electrical characteristics

Unless otherwise noted, min./max. values of characteristics are the lower and upper limits respectively. They are valid within the full operating range. The supply voltage is V_{VDD} = 12 V. Typical values are given at T_i =25°C.

Table 6 Power Supply

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Тур.	Max.		
V _{DD} quiescent current	I _{VDDh}	_	0.86	_	mA	OUT = high
V _{DD} quiescent current	I _{VDDI}	_	1.06	_	mA	OUT = low

Table 7 Undervoltage Lockout 1EDN7550 (Logic level MOSFET)

Parameter	Symbol Values			Unit	Note or Test Condition	
		Min.	Тур.	Max.		
Undervoltage Lockout (UVLO) turn on threshold	<i>UVLO</i> _{on}	3.9	4.2	4.5	V	_
Undervoltage Lockout (UVLO) turn off threshold	<i>UVLO</i> _{off}	_	3.9	_	V	_
UVLO threshold hysteresis	<i>UVLO</i> _{hys}	0.25	0.3	0.35	V	-

Table 8 Undervoltage Lockout 1EDN8550 (Standard MOSFET)

Parameter	Symbol Values			Unit	Note or Test Condition	
		Min.	Тур.	Max.		
Undervoltage Lockout (UVLO) turn on threshold	<i>UVLO</i> _{on}	7.4	8.0	8.6	V	-
Undervoltage Lockout (UVLO) turn off threshold	<i>UVLO</i> _{off}	-	7.0	-	V	-
UVLO threshold hysteresis	<i>UVLO</i> _{hys}	0.8	1.0	1.2	V	-

Table 9 Inputs IN+, IN-

Parameter	Symbol	Symbol Values			Unit	Note or Test Condition
		Min.	Тур.	Max.		
Differential input voltage threshold for transition LH at input resistor	ΔV_{RinH}	-	1.7	-	V	Independent of V_{DD} $R_{in1}/R_{in2} = 33 \text{ k}\Omega^{8}$
Differential input voltage threshold for transition HL at input resistor	ΔV_{RinL}	-	1.5	-	V	Independent of V_{DD} $R_{in1}/R_{in2} = 33 \text{ k}\Omega^{8}$
Total input resistance on each leg	$R_{\rm in1}/R_{\rm in2}$	_	36	-	kΩ	$R_{in1}/R_{in2} = 33 \text{ k}\Omega^{8}$

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Electrical characteristics and parameters

Table 10 **Static Output Characteristics**

Parameter	Symbol	Symbol Values				Note or Test Condition
		Min.	Тур.	Max.		
High-level (sourcing) Output resistance	R _{on_SRC}	-	0.85	-	Ω	I _{SRC} = 50 mA
High-level (sourcing) output current	I _{SRC_peak}	_	4.0	9)	А	-
Low-level (sinking) output resistance	R _{on_SNK}	-	0.35	_	Ω	/ _{SNK} = 50 mA
Low-level (sinking) output current	I _{SNK_Peak}	-	-8.0	10)	А	-

For an illustration of the dynamic characteristics see Figure 5 and Figure 6

Table 11 **Dynamic Characteristics**

Parameter	Symbol		Values		Unit	Note or Test Condition
		Min.	Тур.	Max.		
Input-to-output propagation delay	t_{PDon}	38	45	55	ns	C_{LOAD} = 200 pF, V_{DD} = 12 V
Input-to-output propagation delay	t_{PDoff}	38	45	55	ns	C_{LOAD} = 200 pF, V_{DD} = 12 V
Rise time	t _{rise}	_	6.5	15 ¹¹⁾	ns	C _{LOAD} = 1.8 nF, V _{DD} = 12 V
Fall time	t_{fall}	_	4.5	15 ¹¹⁾	ns	C _{LOAD} = 1.8 nF, V _{DD} = 12 V
Rise time	t_{rise}	_	1	5 ¹¹⁾	ns	C _{LOAD} = 200 pF, V _{DD} = 12 V
Fall Time	t_{fall}	_	1	5 ¹¹⁾	ns	C _{LOAD} = 200 pF, V _{DD} = 12 V
Minimum input pulse width that changes output state	$t_{\sf PW}$	_	25	_	ns	C _{LOAD} = 1.8 nF, V _{DD} = 12 V

⁹ Actively limited by design to approx. 5.2 A_{pk}, parameter is not subject to production test - verified by design / characterization

¹⁰ Actively limited by design approx. -10.4 A_{pk} , parameter is not subject to production test - verified by design / characterization

¹¹ Parameter verified by design, not 100% tested in production



Electrical characteristics and parameters

Timing diagram 4.5

Figure 5 depicts rise, fall and delay times as given in the Chapter 4.

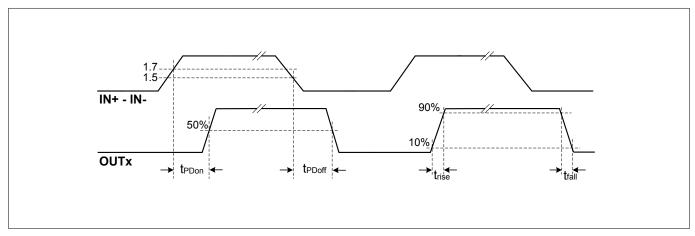


Figure 5 Propagation delay, rise and fall time

Figure 6 illustrates the Undervoltage Lockout function.

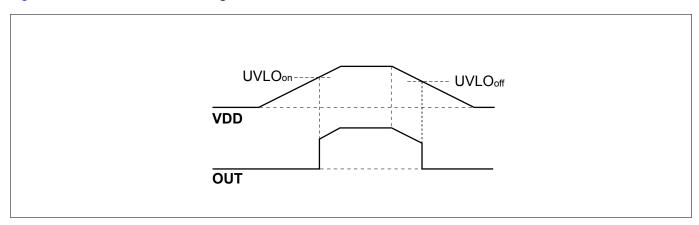


Figure 6 **UVLO Behavior (output state high)**



Typical characteristics

Typical characteristics 5

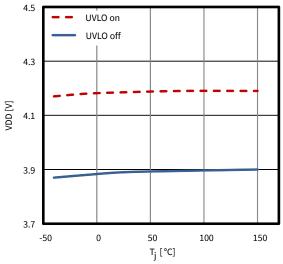


Figure 7 **Undervoltage Lockout threshold** (1EDN7550) vs temperature

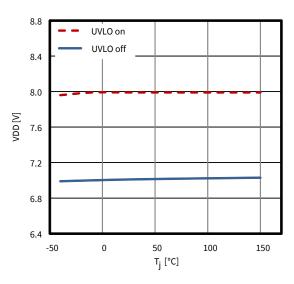


Figure 8 **Undervoltage Lockout threshold** (1EDN8550) vs temperature

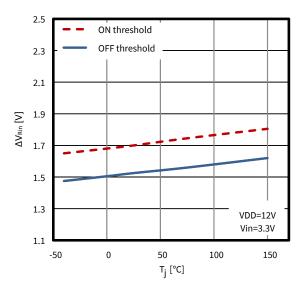
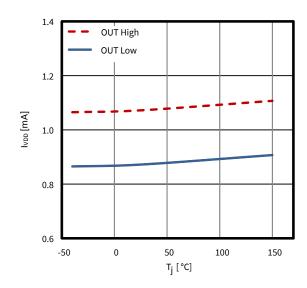


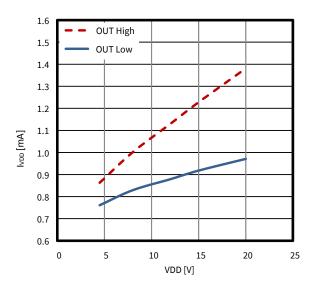
Figure 9 Differential input voltage threshold vs temperature



Typical quiescent current vs Figure 10 temperature



Typical characteristics



Typical quiescent current vs supply Figure 11 voltage

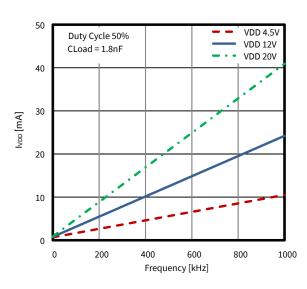
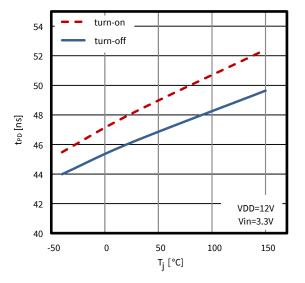
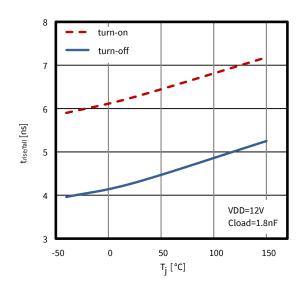


Figure 12 **Total operating current consumption** with capacitive load vs frequency



Typical propagation delay vs Figure 13 temperature



Typical rise and fall time vs Figure 14 temperature



Typical applications

6 Typical applications

6.1 Switches with Kelvin source connection (4-pin packages)

This is one of the key target applications of 1EDNx550. The 4-pin configuration depicted in *Figure 15* is a very effective measure to improve the switching performance of transistors in packages with high source inductance L_S as is typical for the widely used TO-packages. Although the Kelvin Source connection SS solves the problem of the largely increased switching losses due to L_S , it is evident, that the gate driver reference potential is moving by the inductive voltage drop v_{LS} with respect to the system ground SGND. In fast-switching applications at high current, v_{LS} can reach 100 V and above. This is why 4-pin systems so far either used isolated drivers or external filters with relatively low corner frequency that add significant signal delay. Now, however, 1EDNx550 provides an optimum solution for this case.

Figure 15 also indicates that the usually SGND-related VDD cannot be used directly as the driver supply. But due to the high frequency of v_{LS} (> 100 MHz), a filter composed of impedance Z_{VDD} together with the blocking cap C_{VDD} is well suited to generate a sufficiently stable driver supply. Z_{VDD} can be either a resistor (e.g. 22 Ω with a typical C_{VDD} of 1 μF) or, even better, a proper ferrite bead.

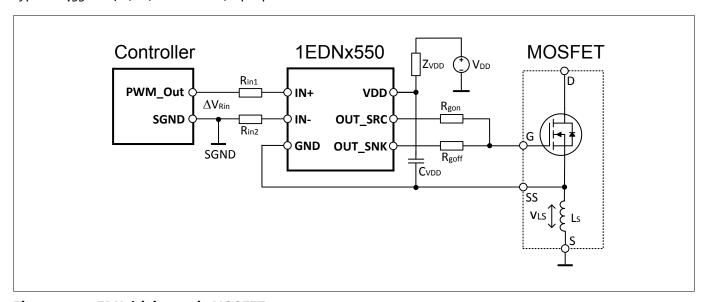


Figure 15 1EDN driving 4-pin MOSFET

6.2 Applications with significant parasitic PCB-inductances

In fast switching power systems the unavoidable parasitic inductance associated with any electrical connection may cause significant inductive voltage drops, particularly if the PCB-layout cannot be optimized, the most common reasons being limitations in the number of PCB-layers, geometric restrictions or also the lack of specific experience. In such situations the high robustness of 1EDNx550 with respect to "switching noise" (high-frequency voltage between reference potential of driver and controller) is extremely valuable and allows good performance even in systems with formerly critical layout. *Figure 16* indicates a respective example, indicating the most relevant parasitic PCB-inductances.



Typical applications

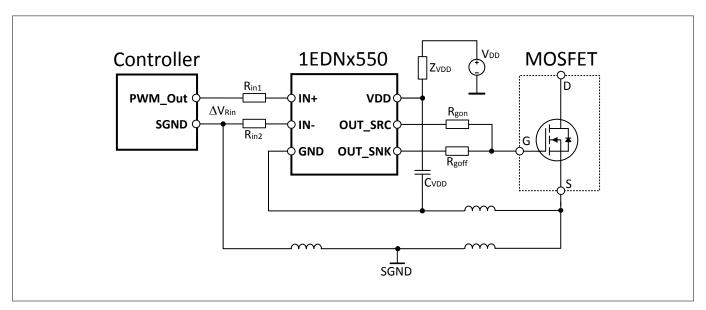


Figure 16 Application with significant PCB inductance

6.3 Switches with bipolar gate drive

Another application 1EDNx550 is tailored for, is driving power switches that require a negative gate-to-source voltage to safely hold them in the "off" state. Although MOSFETs are usually operated at zero "off" voltage, in certain situations a negative gate drive voltage can be very helpful. Particularly the fast switching "off" of high current when using switches with large common source inductance (e.g. in 3-pin TO-packages) may become critical in terms of losses and stability with a zero "off" level. In such cases a negative gate drive voltage is able to significantly improve switching performance. As depicted in *Figure 17*, this kind of application is completely uncritical and handled easily with 1EDNx550, while standard drivers cannot be applied directly without adaptations.

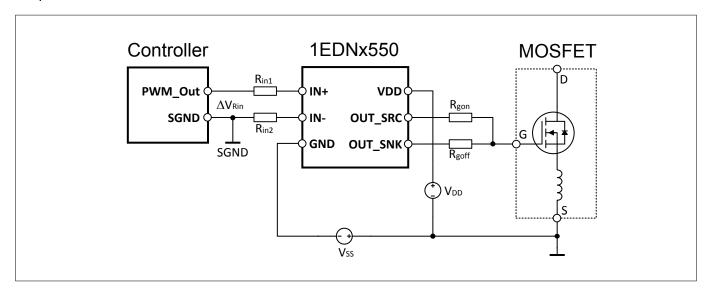


Figure 17 Bipolar gate drive for 3-pin MOSFET

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Typical applications

6.4 High-side switches

Due to the large static input common-mode range, even driving high-side switches is an interesting application field for 1EDNx550. Although not providing galvanic isolation, 1EDNx550 can functionally be used as a high-side driver, as long as the power-loop voltage VP does not cause a violation of the allowed common-mode range. In high-side operation as depicted in *Figure 18*, the driver ground GND switches between zero ("off" state) and VP ("on" state) with respect to SGND; the resulting common-mode voltage at the driver input pins (0 and –VP / 12, resp.) is restricted to - 7 V (*Table 5*) and by that limits VP to 84 V. In many applications the driver supply voltage can be generated by means of the well-known bootstrapping method also indicated in *Figure 18*.

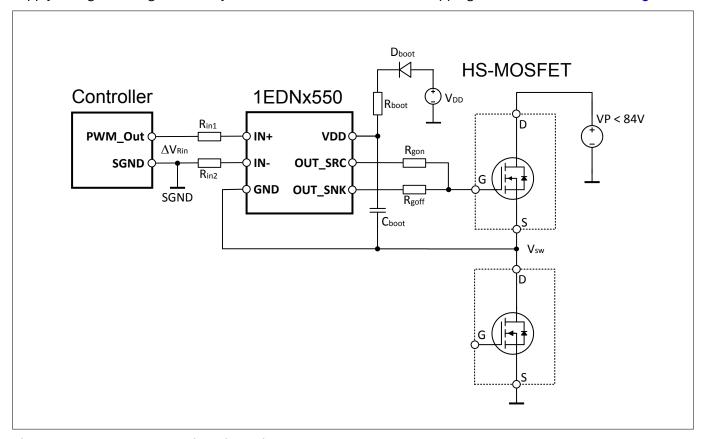


Figure 18 1EDNx550 as a high-side driver

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Layout guidelines

7 **Layout guidelines**

It is well-known that the layout of a fast-switching power system is a critical task with strong influence on the overall performance. This is why there exists a huge number of rules, recommendations, guidelines, tips and tricks exist that should help to finally end up with a proper system layout.

With 1EDNx550 one of the central layout problems, namely the design of the grounding network, has become much less critical due to the highly reduced sensitivity of the differential concept with respect to ground voltage differences. So layout rules can be restricted to the following rather simple and evident ones:

- place input resistors R_{in} close to the driver and make layout of input signal path as symmetric and as compact as possible
- use a low-ESR decoupling capacitance for the VDD supply and place it as close as possible to the driver
- minimize power loop inductance as the most critical limitation of switching speed due to the resulting unavoidable voltage overshoots

A layout recommendation for the input path is given in *Figure 19*.

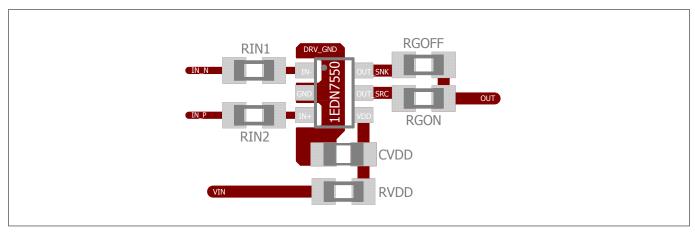
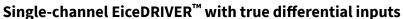


Figure 19 **Layout recommendation**





Package dimensions

Package dimensions 8

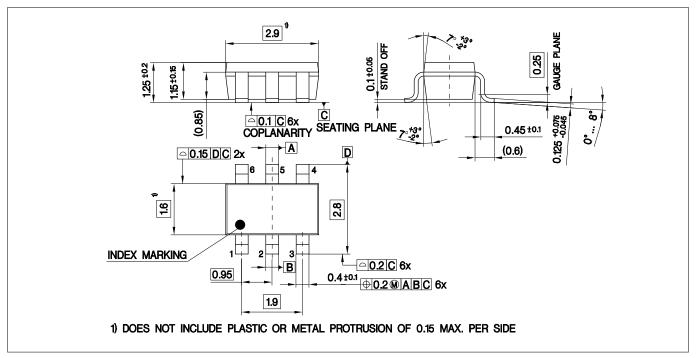


Figure 20 **SOT23** 6-pin outline dimensions

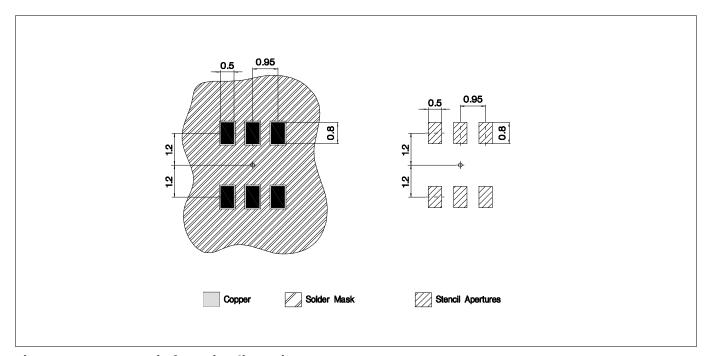


Figure 21 SOT23 6-pin footprint dimension

Single-channel EiceDRIVER[™] with true differential inputs



Package dimensions

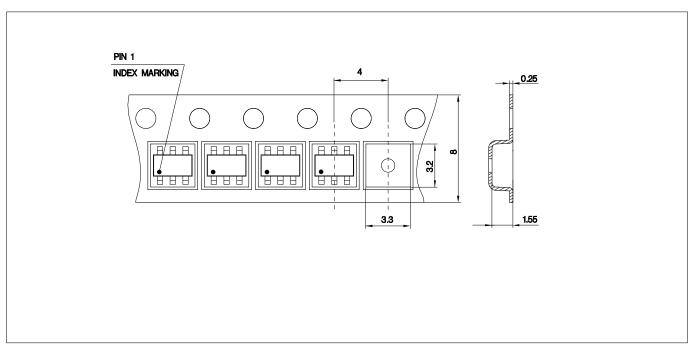


Figure 22 SOT23 6-pin packaging dimensions

Notes:

1. For further details, please visit www.infineon.com/packages

Single-channel $\mathbf{EiceDRIVER}^{\mathbf{TM}}$ with true differential inputs



Revision history

Revision history

Document version	Date of release	Description of changes
Rev. 2.0	2018-05-14	Final Datasheet created

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